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ISOTOP[®] Buck chopper NPT IGBT

$V_{CES} = 600V$ $I_{C} = 50A$ @ Tc = 90°C

Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

- Non Punch Through (NPT) THUNDERBOLT IGBT
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 100 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
- ISOTOP[®] Package (SOT-227)
- Very low stray inductance
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive T_C of V_{CEsat}
- RoHS Compliant

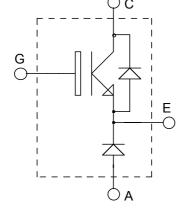
Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V _{CES}	Collector - Emitter Breakdown Voltage		600	V
I _{C1}	Continuous Collector Current	$T_C = 25^{\circ}C$	75	
I _{C2}	T _C =		50	А
I _{CM}	Pulsed Collector Current	$T_C = 25^{\circ}C$	160	
V _{GE}	Gate – Emitter Voltage		±20	V
P_D	Maximum Power Dissipation	$T_C = 25^{\circ}C$	277	W
I_{LM}	RBSOA clamped Inductive load Current $R_G=11\Omega$		100	А
IF _{AV}	Maximum Average Forward Current Duty cycle=0.5	$T_C = 80^{\circ}C$	30	А
IF _{RMS}	RMS Forward Current (Square wave, 50% duty)		39	Л

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
т	Zero Gate Voltage Collector Current	$V_{GE} = 0V$	$T_j = 25^{\circ}C$			40	μA
I _{CES}	Zero Gate Voltage Collector Current	$V_{CE} = 600 V$	$T_{j} = 125^{\circ}C$			1000	μA
V _{CE(sat)}	Collector Emitter saturation Voltage	$V_{GE} = 15V$	$T_j = 25^{\circ}C$		2.1	2.7	V
		$I_{\rm C} = 50 {\rm A}$ $T_{\rm j} = 125$	$T_{j} = 125^{\circ}C$		2.2	2.8	v
V _{GE(th)}	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 700 \mu A$		4.5	5.5	6.5	V
I _{GES}	Gate – Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V$				±100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
Cies	Input Capacitance	$V_{GE} = 0V$		2250		
C _{oes}	Output Capacitance	$V_{CE} = 25V$		255		pF
C _{res}	Reverse Transfer Capacitance	f = 1 MHz		155		
Qg	Total gate Charge	$V_{GS} = 15V$		175		
Q _{ge}	Gate – Emitter Charge	$V_{Bus} = 300V$		18		nC
Q _{gc}	Gate – Collector Charge	$I_C = 50A$		100		
T _{d(on)}	Turn-on Delay Time	Resistive Switching (25°C)		29		ns
Tr	Rise Time	$V_{GE} = 15V$ $V_{Bus} = 300V$		118		
T _{d(off)}	Turn-off Delay Time	$V_{Bus} = 500 V$ $I_C = 50 A$		150		
T _f	Fall Time	$R_G = 10\Omega$		190		
T _{d(on)}	Turn-on Delay Time	Inductive Switching (25°C)		30		ns
Tr	Rise Time	$V_{GE} = 15V$		80		
T _{d(off)}	Turn-off Delay Time	$V_{Bus} = 400V$ $I_C = 50A$		240		
T _f	Fall Time	$\frac{R_{\rm C} = 30 \Lambda}{R_{\rm G} = 10 \Omega}$		43		
Ets	Total switching Losses			3.6		mJ
T _{d(on)}	Turn-on Delay Time	Inductive Switching (150°C)		28		
Tr	Rise Time	$V_{GE} = 15V$		75		
T _{d(off)}	Turn-off Delay Time	$V_{Bus} = 400V$ $I_{C} = 50A$ $R_{G} = 10\Omega$		265		ns
T _f	Fall Time			185		
Eon	Turn-on Switching Energy			1.8		
E _{off}	Turn-off Switching Energy			2.4		mJ
E _{ts}	Total switching Losses			4.2		



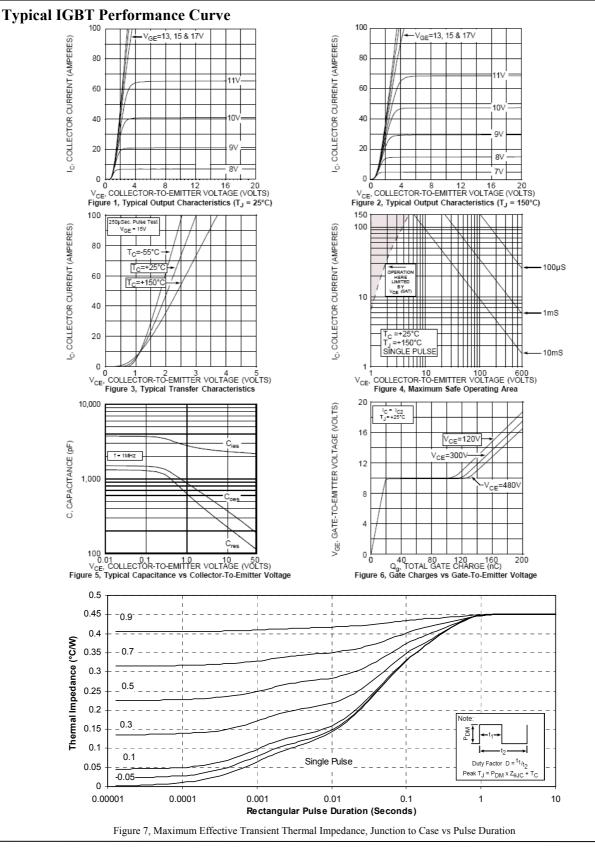
Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
	Diode Forward Voltage	$I_F = 30A$			1.6	1.8	
$V_{\rm F}$		$I_F = 60A$			1.9		V
		$I_F = 30A$	$T_{i} = 125^{\circ}C$		1.4		
I _{RM}	Maximum Reverse Leakage Current	$V_{R} = 600 V$	$T_j = 25^{\circ}C$			250	μA
IRM		$V_{R} = 600 V$	$T_{j} = 125^{\circ}C$			500	μΛ
CT	Junction Capacitance	$V_{R} = 200 V$			44		pF
4	Reverse Recovery Time	$I_F=1A, V_R=30V$ di/dt =100A/µs	$T_j = 25^{\circ}C$		23		
t _{rr}	Reverse Recovery Time	$T_i = 25^{\circ}C$ $T_i = 125^{\circ}C$	$T_i = 25^{\circ}C$		85		ns
				160			
I _{RRM}	Maximum Reverse Recovery Current	$I_{\rm F} = 30 \text{A}$ $V_{\rm R} = 400 \text{V}$	$T_j = 25^{\circ}C$		4		А
IRRM	Maximum Reverse Recovery Current		$T_{i} = 125^{\circ}C$		8		Л
0	Paulana Pagayany Changa	$di/dt = 200 A/\mu s$	$T_j = 25^{\circ}C$		130		nC
Q _{rr}	Reverse Recovery Charge		$T_{j} = 125^{\circ}C$		700		IIC
t _{rr}	Reverse Recovery Time	$I_F = 30A$ $V_R = 400V$ $di/dt = 1000A/\mu s$			70		ns
Q _{rr}	Reverse Recovery Charge		$T_{j} = 125^{\circ}C$		1300		nC
I _{RRM}	Maximum Reverse Recovery Current				30		Α

Thermal and package characteristics

Symbol	Characteristic		Min	Тур	Max	Unit	
R _{thJC}	Junction to Case Thermal Resistance	IGBT			0.45		
R _{thJC}		Diode			1.21	°C/W	
R _{thJA}	Junction to Ambient (IGBT & Diode)				20		
V _{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz		2500			V	
T_J, T_{STG}	Storage Temperature Range		-55		150	°C	
T _L	Max Lead Temp for Soldering:0.063" from case for 10 sec				300	7 C	
Torque	Mounting torque (Mounting = 8-32 or 4mm Machine and terminals = 4mm Machine)				1.5	N.m	
Wt	Package Weight			29.2		g	



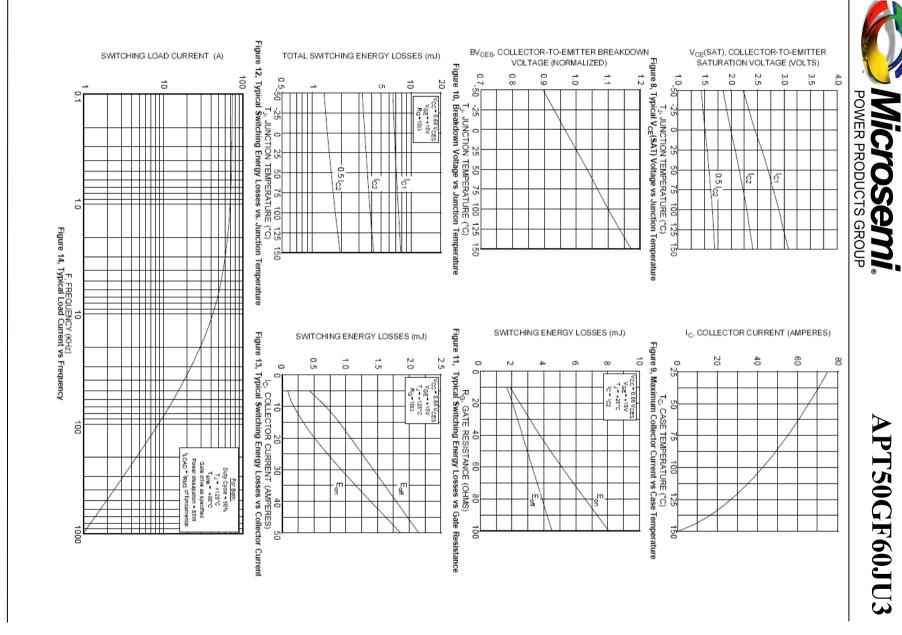


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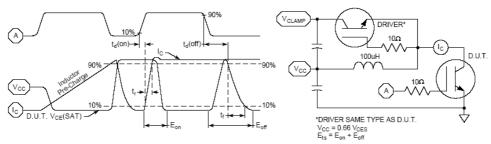


Figure 16, Switching Loss Test Circuit and Waveforms

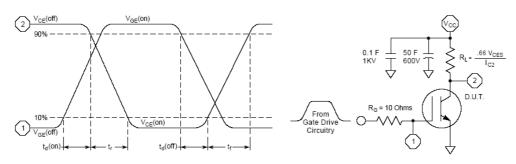
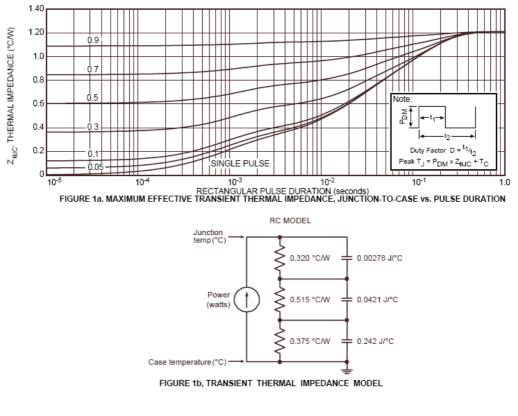


Figure 17, Resistive Switching Time Test Circuit and Waveforms

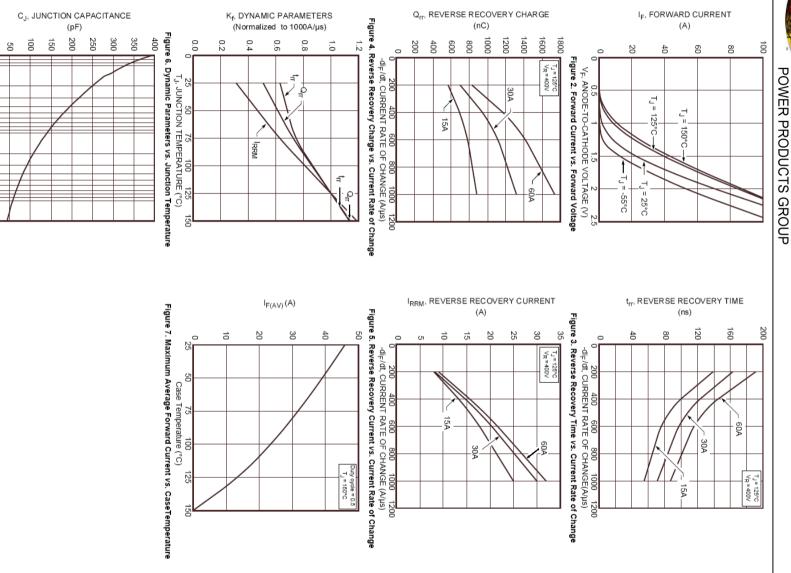
Typical Diode Performance Curve



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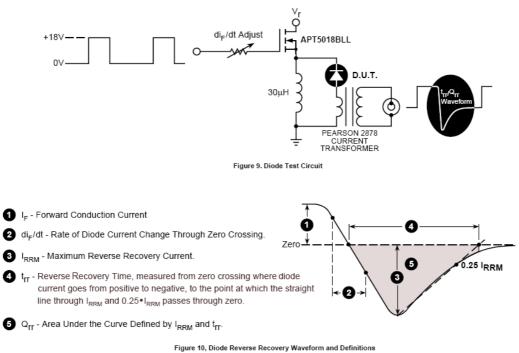
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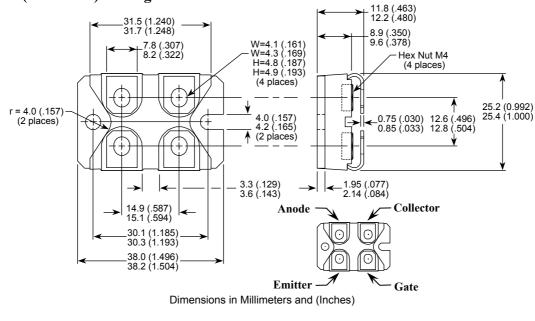
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SOT-227 (ISOTOP[®]) Package Outline



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